

## Description

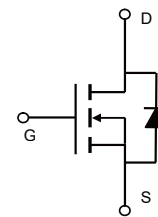
The VST12N040 uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

## General Features

- $V_{DS} = 120V, I_D = 129A$   
 $R_{DS(ON)} < 5.5m\Omega @ V_{GS} = 10V$
- Excellent gate charge x  $R_{DS(on)}$  product
- Very low on-resistance  $R_{DS(on)}$
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

## Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



Schematic

## Package Marking and Ordering Information

| Device Marking | Device       | Device Package | Reel Size | Tape width | Quantity |
|----------------|--------------|----------------|-----------|------------|----------|
| VST12N040      | VST12N040-T3 | TO-263         | -         | -          | -        |

## Absolute Maximum Ratings ( $T_c = 25^\circ\text{C}$ unless otherwise noted)

| Parameter                                             | Symbol                   | Limit      | Unit                |
|-------------------------------------------------------|--------------------------|------------|---------------------|
| Drain-Source Voltage                                  | $V_{DS}$                 | 120        | V                   |
| Gate-Source Voltage                                   | $V_{GS}$                 | $\pm 20$   | V                   |
| Drain Current-Continuous                              | $I_D$                    | 129        | A                   |
| Drain Current-Continuous( $T_c = 100^\circ\text{C}$ ) | $I_D(100^\circ\text{C})$ | 92         | A                   |
| Pulsed Drain Current                                  | $I_{DM}$                 | 480        | A                   |
| Maximum Power Dissipation                             | $P_D$                    | 185        | W                   |
| Derating factor                                       |                          | 1.3        | W/ $^\circ\text{C}$ |
| Single pulse avalanche energy (Note 1)                | $E_{AS}$                 | 1000       | mJ                  |
| Operating Junction and Storage Temperature Range      | $T_J, T_{STG}$           | -55 To 175 | $^\circ\text{C}$    |

## Thermal Characteristic

|                                     |                 |     |                      |
|-------------------------------------|-----------------|-----|----------------------|
| Thermal Resistance,Junction-to-Case | $R_{\theta JC}$ | 0.8 | $^{\circ}\text{C/W}$ |
|-------------------------------------|-----------------|-----|----------------------|

**Electrical Characteristics ( $T_c=25^{\circ}\text{C}$  unless otherwise noted)**

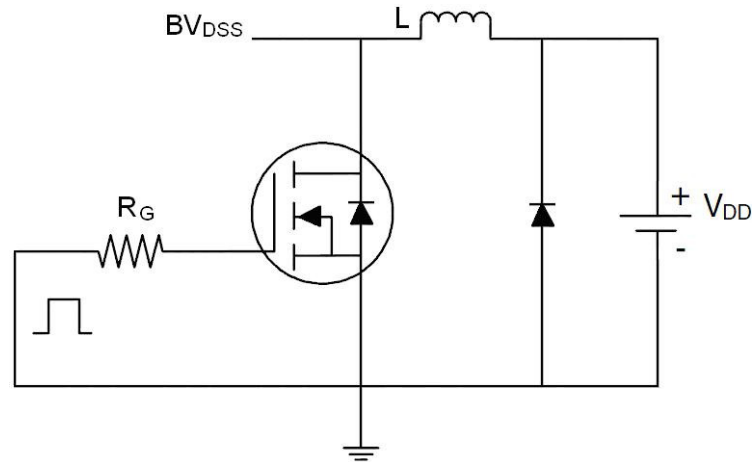
| Parameter                          | Symbol       | Condition                                              | Min | Typ  | Max       | Unit       |
|------------------------------------|--------------|--------------------------------------------------------|-----|------|-----------|------------|
| Off Characteristics                |              |                                                        |     |      |           |            |
| Drain-Source Breakdown Voltage     | $BV_{DSS}$   | $V_{GS}=0V, I_D=250\mu A$                              | 120 |      | -         | V          |
| Zero Gate Voltage Drain Current    | $I_{DSS}$    | $V_{DS}=120V, V_{GS}=0V$                               | -   | -    | 1         | $\mu A$    |
| Gate-Body Leakage Current          | $I_{GSS}$    | $V_{GS}=\pm 20V, V_{DS}=0V$                            | -   | -    | $\pm 100$ | nA         |
| On Characteristics                 |              |                                                        |     |      |           |            |
| Gate Threshold Voltage             | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$                          | 2.5 | 3.3  | 4.5       | V          |
| Drain-Source On-State Resistance   | $R_{DS(ON)}$ | $V_{GS}=10V, I_D=60A$                                  | -   | 4.8  | 5.5       | m $\Omega$ |
| Forward Transconductance           | $g_{FS}$     | $V_{DS}=10V, I_D=60A$                                  | 60  | -    | -         | S          |
| Dynamic Characteristics            |              |                                                        |     |      |           |            |
| Input Capacitance                  | $C_{iss}$    | $V_{DS}=50V, V_{GS}=0V,$<br>$F=1.0MHz$                 | -   | 5600 | -         | PF         |
| Output Capacitance                 | $C_{oss}$    |                                                        | -   | 641  | -         | PF         |
| Reverse Transfer Capacitance       | $C_{rss}$    |                                                        | -   | 28   | -         | PF         |
| Switching Characteristics (Note 2) |              |                                                        |     |      |           |            |
| Turn-on Delay Time                 | $t_{d(on)}$  | $V_{DD}=60V, I_D=60A$<br>$V_{GS}=10V, R_G=4.7\Omega$   | -   | 16   | -         | nS         |
| Turn-on Rise Time                  | $t_r$        |                                                        | -   | 67   | -         | nS         |
| Turn-Off Delay Time                | $t_{d(off)}$ |                                                        | -   | 45   | -         | nS         |
| Turn-Off Fall Time                 | $t_f$        |                                                        | -   | 14   | -         | nS         |
| Total Gate Charge                  | $Q_g$        | $V_{DS}=60V, I_D=60A,$<br>$V_{GS}=10V$                 | -   | 84.7 | -         | nC         |
| Gate-Source Charge                 | $Q_{gs}$     |                                                        | -   | 30.6 | -         | nC         |
| Gate-Drain Charge                  | $Q_{gd}$     |                                                        | -   | 18.3 | -         | nC         |
| Drain-Source Diode Characteristics |              |                                                        |     |      |           |            |
| Diode Forward Voltage              | $V_{SD}$     | $V_{GS}=0V, I_S=129A$                                  | -   |      | 1.2       | V          |
| Diode Forward Current              | $I_S$        |                                                        | -   | -    | 129       | A          |
| Reverse Recovery Time              | $t_{rr}$     | $T_J = 25^{\circ}C, I_F = I_S$<br>$di/dt = 100A/\mu s$ | -   | 60   |           | nS         |
| Reverse Recovery Charge            | $Q_{rr}$     |                                                        | -   | 140  |           | nC         |

**Notes:**

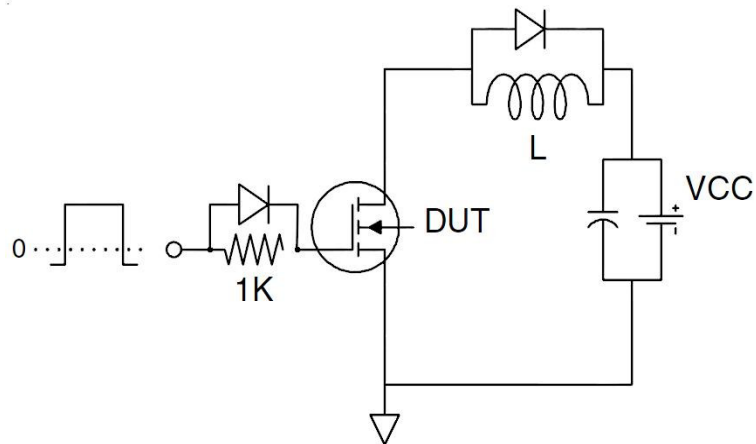
1. EAS condition :  $T_J=25^{\circ}\text{C}, V_{DD}=50V, V_G=10V, L=0.5\text{mH}, R_G=25\Omega$
2. Guaranteed by design, not subject to production
3. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of  $T_J(\text{MAX})=175^{\circ}\text{C}$ . The SOA curve provides a single pulse rating.

## Test Circuit

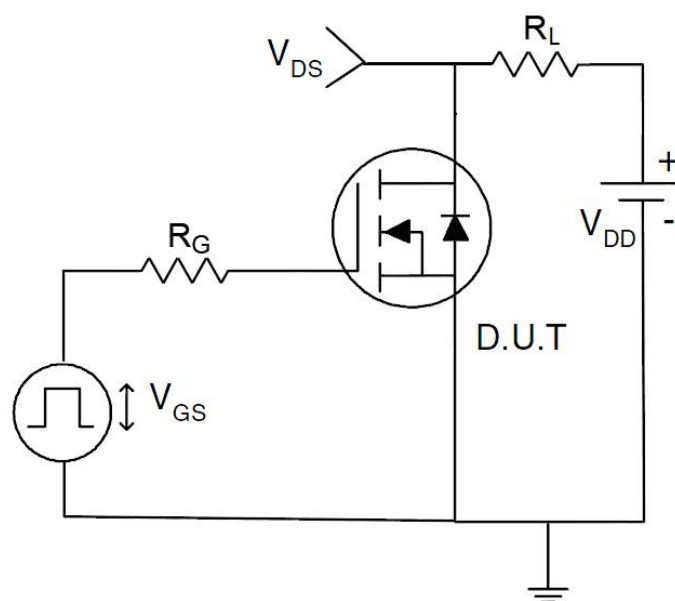
### 1) $E_{AS}$ test Circuit



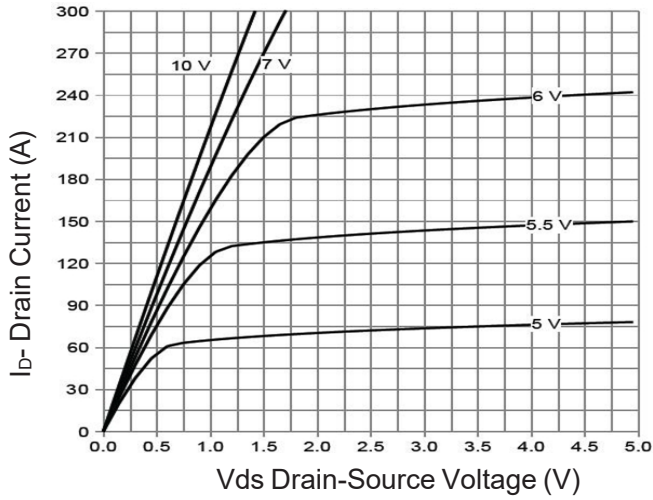
### 2) Gate charge test Circuit



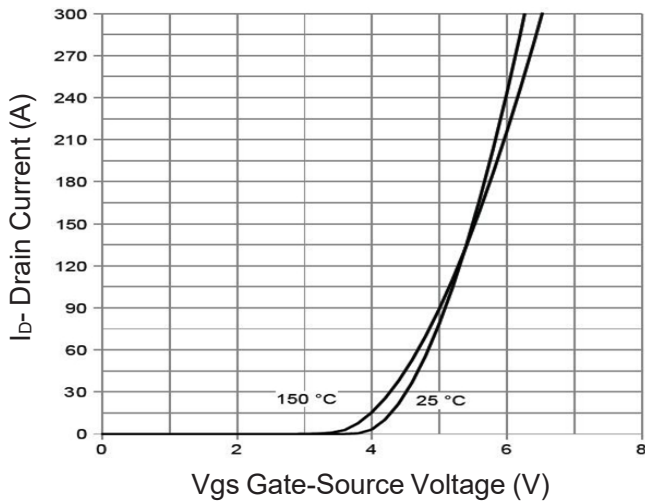
### 3) Switch Time Test Circuit



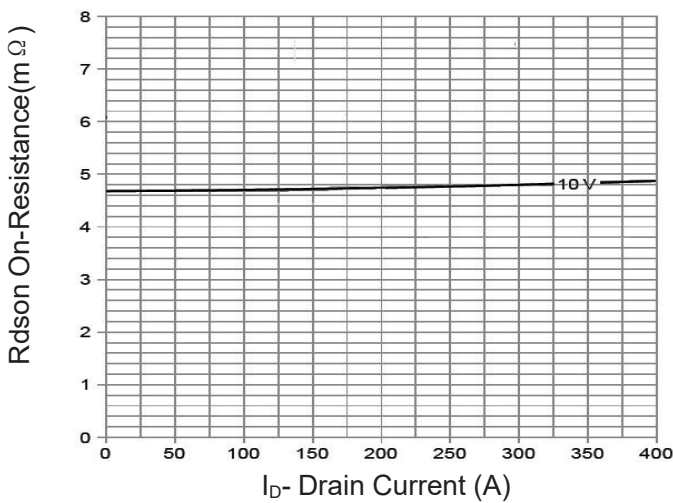
## Typical Electrical and Thermal Characteristics



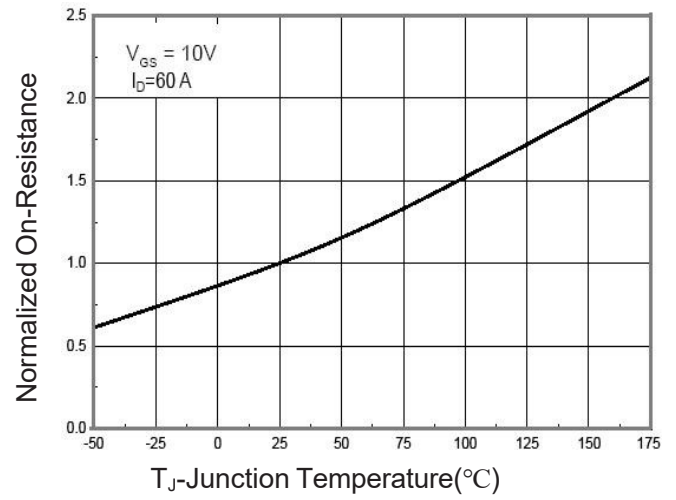
**Figure 1 Output Characteristics**



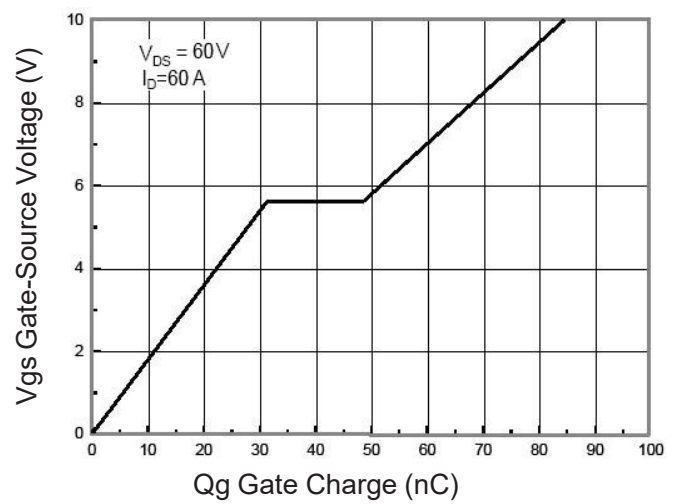
**Figure 2 Transfer Characteristics**



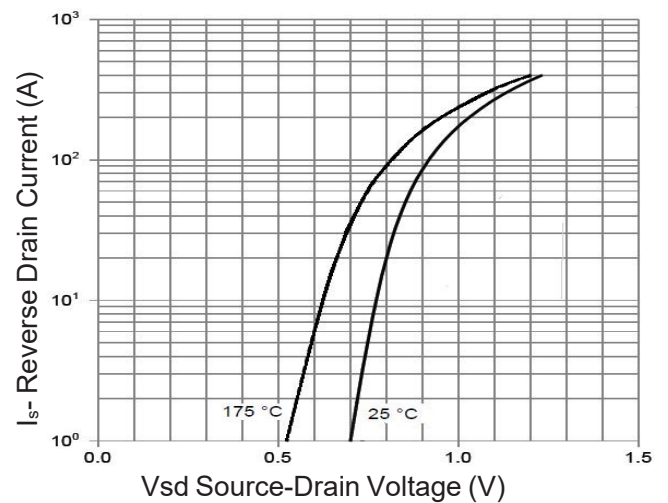
**Figure 3 Rdson- Drain Current**



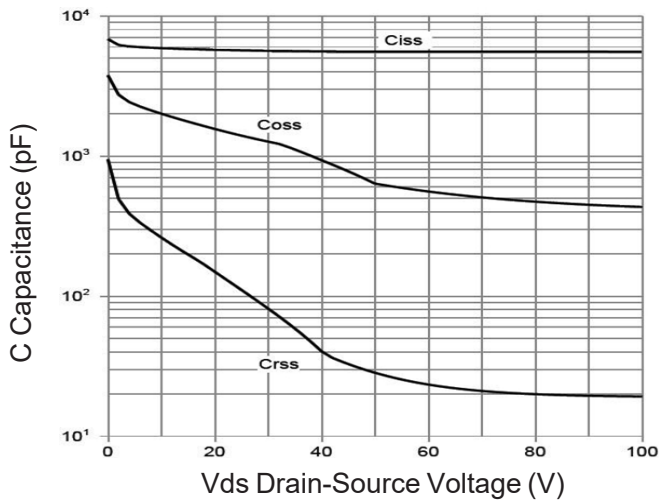
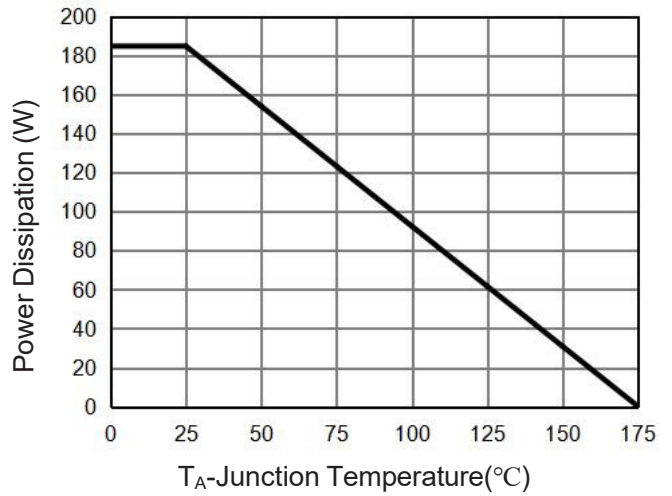
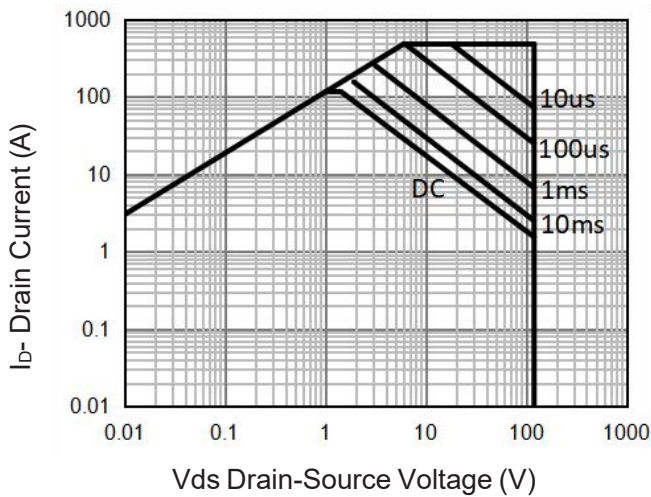
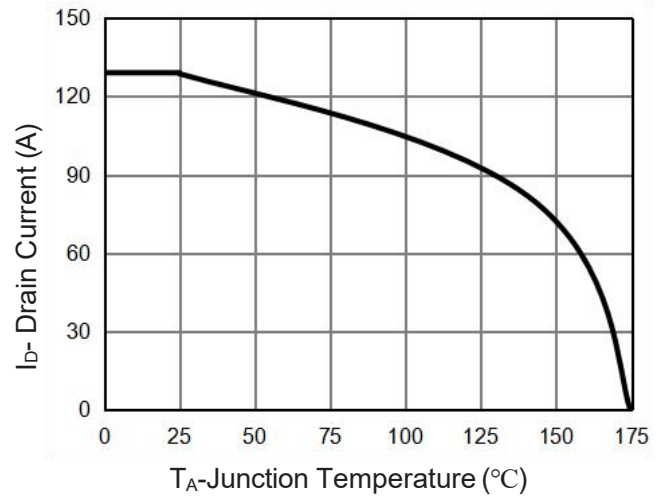
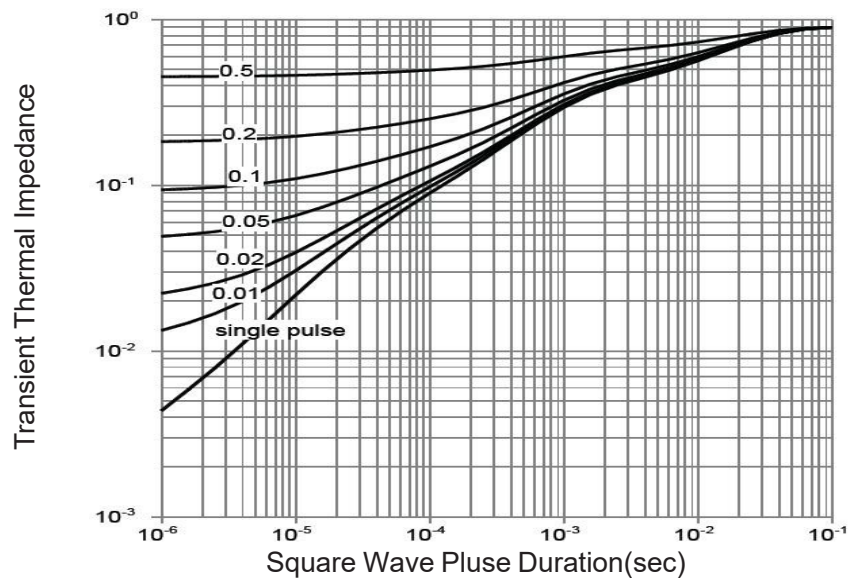
**Figure 4 Rdson-Junction Temperature**



**Figure 5 Gate Charge**



**Figure 6 Source- Drain Diode Forward**


**Figure 7 Capacitance vs Vds**

**Figure 9 Power De-rating**

**Figure 8 Safe Operation Area** (Note3)

**Figure 10 Current De-rating**

**Figure 11 Normalized Maximum Transient Thermal Impedance**